

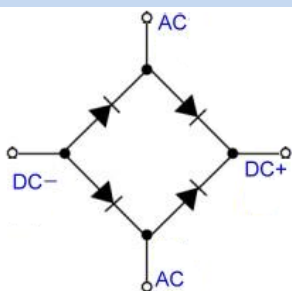
/ Descriptions

GBU

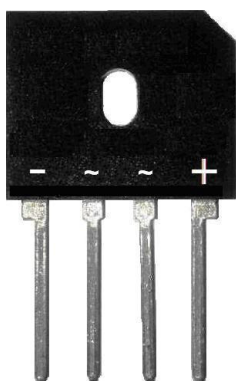
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



/ hFE Classifications & Marking

/ Absolute Maximum Ratings(Ta=25)

		×	
	θ		°C
			°C
		~	°C

/ Electrical Characteristics(Ta=25)

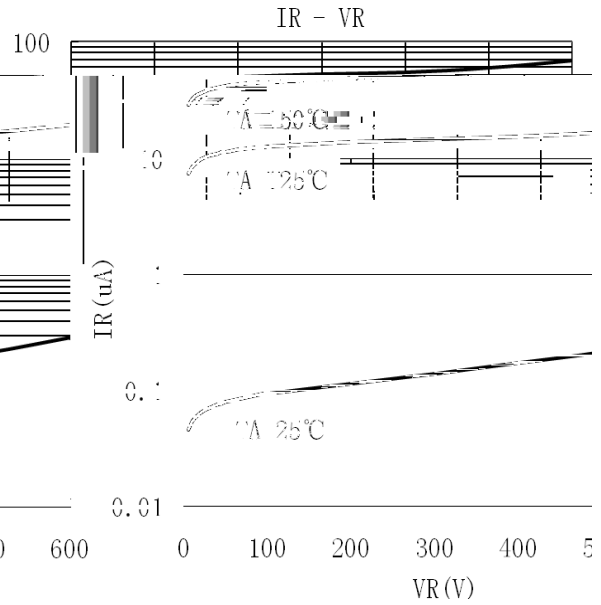
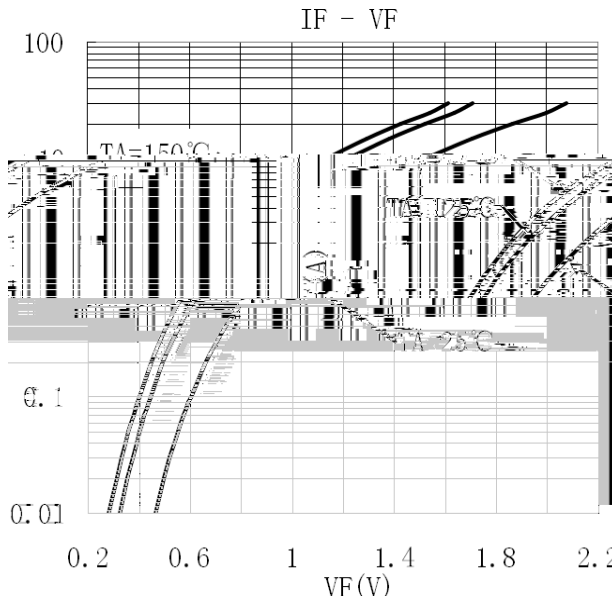
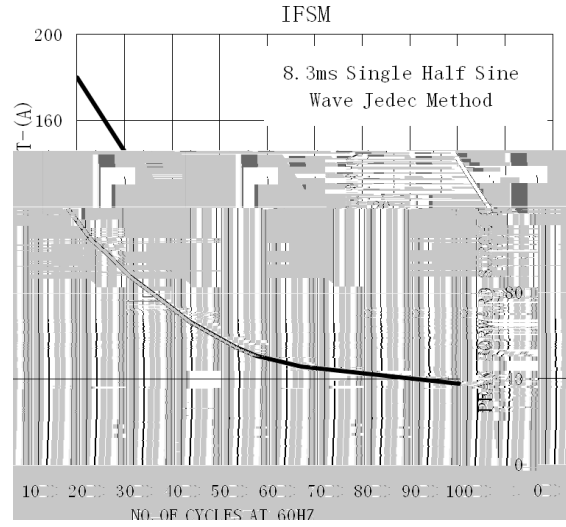
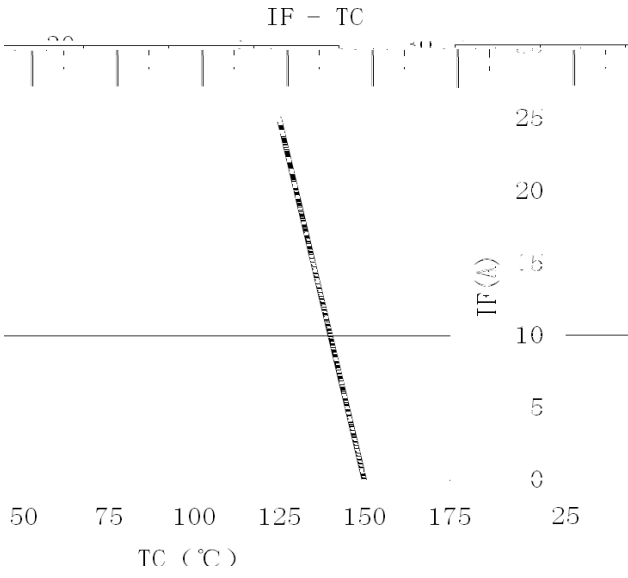
		°C				
		°C				
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		°C				
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	()	°C				μ
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/ :

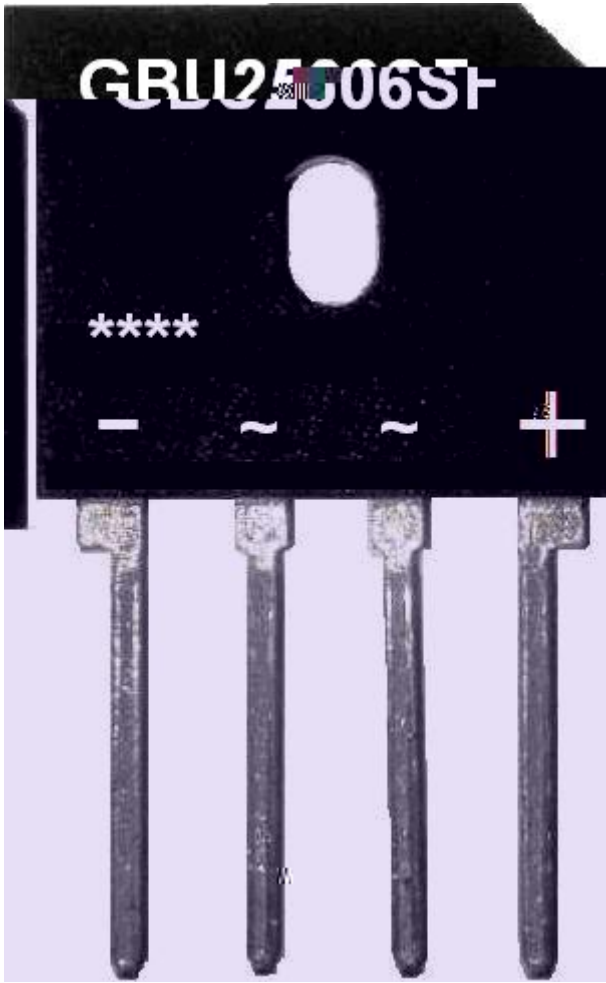
/

/

/ Electrical Characteristic Curve



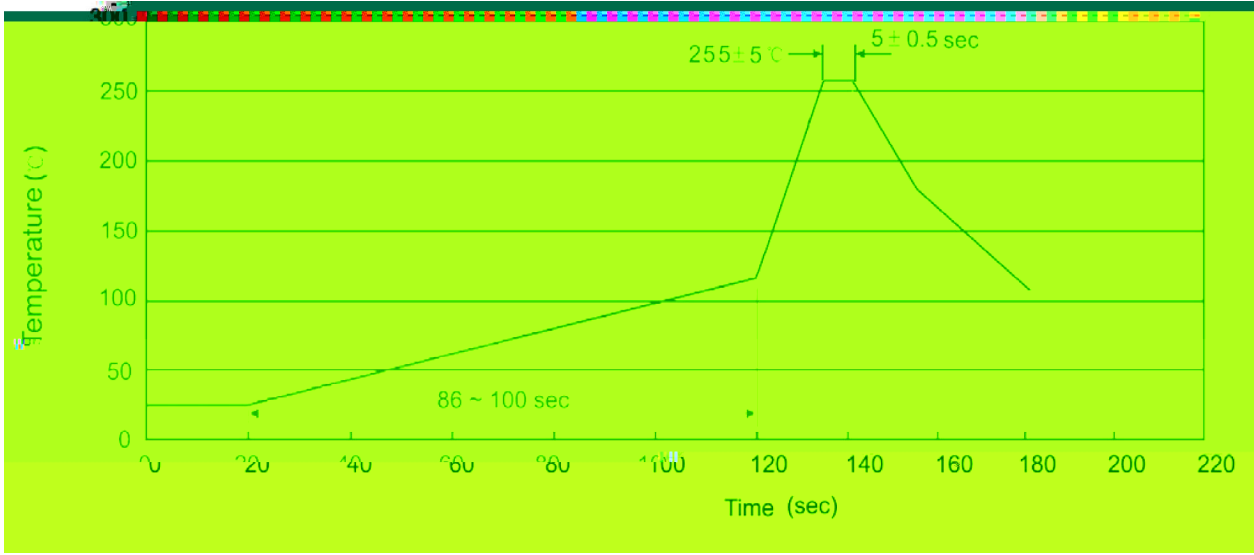
/ Marking Instructions



- AC +

- AC + Pin function

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± °C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Bag 只/袋	Bags/Inner Box 袋/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Bag 袋	Inner Box 盒	Outer Box 箱
GBU	-	-	500	10	5,000	-	230×205×48	435×240×255

/ Notices